



LIGITEK ELECTRONICS CO.,LTD.
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LED SMD



Lead-Free Parts

LG-110WK-DTR-P-B01

DATA SHEET

DOC. NO : QW0905-LG-110WK-DTR-P-B01

REV : B

DATE : 03 - Mar. - 2017



Features:

1. Package in 8.0mm carrier tape on 7" diameter reel.
2. Compatible with automatic placement equipment.
3. Compatible with reflow solder process.

Descriptions:

1. The LG-110 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
2. Besides, lightweight makes them ideal for miniature applications. etc.

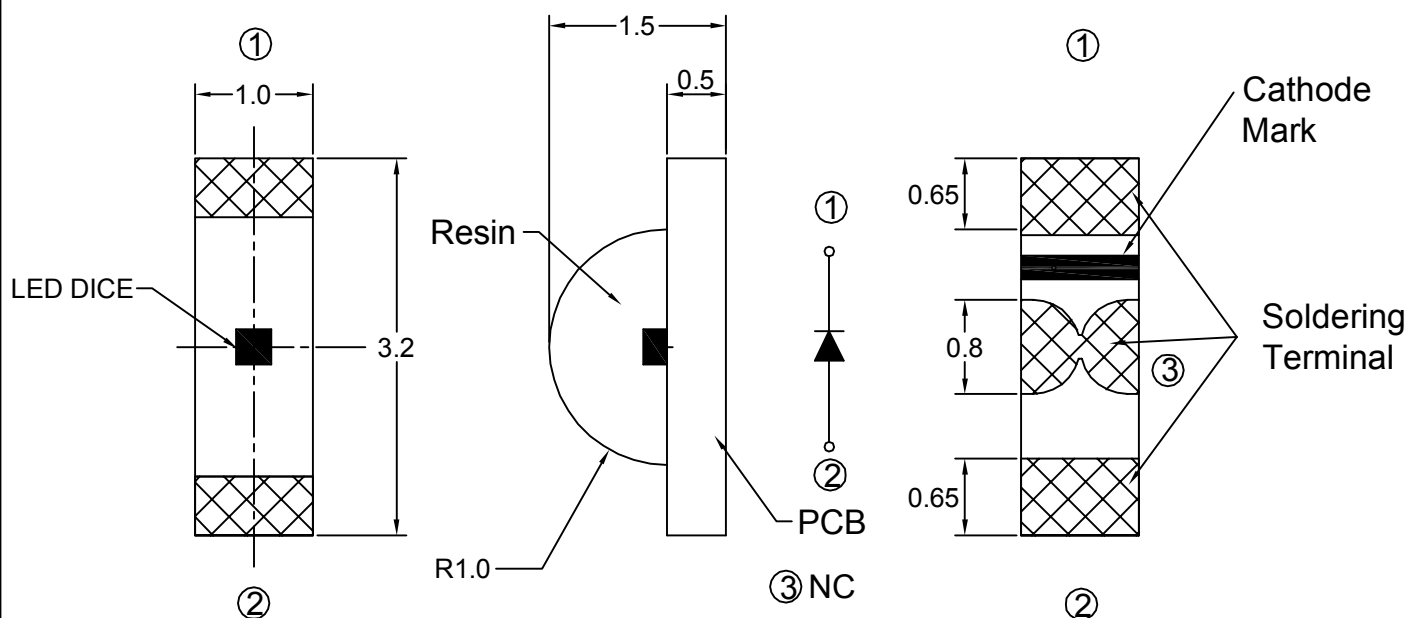
Applications:

1. Automotive : backlighting in dashboard and switch.
2. Telecommunication : indicator and backlighting in telephone and fax.
3. Flat backlight for LCD, switch and symbol
4. General use.

Device Selection Guide:

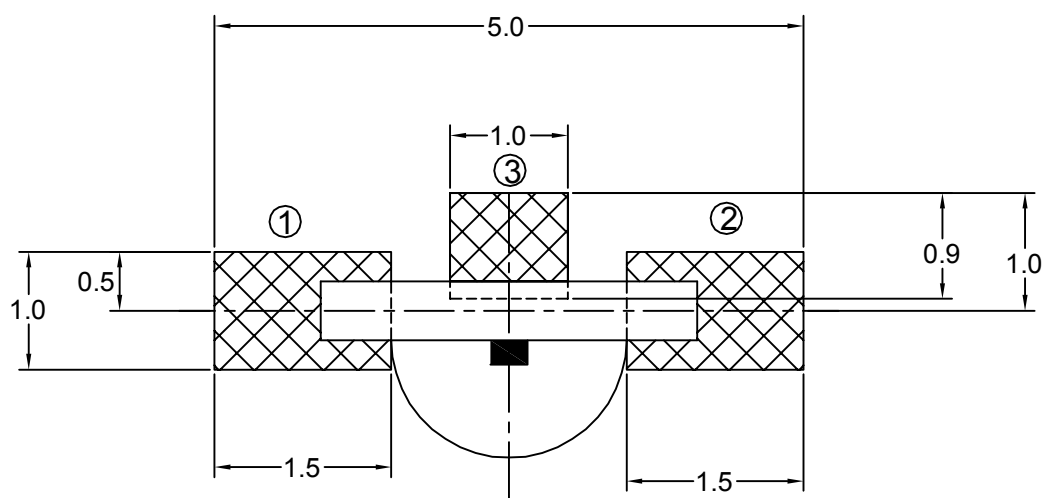
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LG-110WK-DTR-P-B01	InGaN	White	Yellow Diffused

Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.1\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle $\pm 0.5^\circ$. Unit=mm.

Absolute Maximum Ratings

Parameter	Symbol	Ratings	UNIT
Forward Current*	IF	20	mA
Peak Forward Current Duty 1/10@10KHz*	IFP	100	mA
Power Dissipation*	PD	72	mW
Reverse Current @5V*	Ir	50	μA
Electrostatic Discharge*	ESD	500	V
Operating Temperature	Topr	- 40 ~ + 85	°C
Storage Temperature	Tstg	- 40 ~ + 100	°C

* Ambient test condition : TA=25 °C

Typical Electrical & Optical Characteristics (Ta=25 °C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION
Luminous Intensity	Iv	200	500	----	mcd	IF=20mA
Chromaticity Coordinates	x	0.26	----	0.29	nm	IF=20mA
	y	0.225	----	0.31	nm	IF=20mA
Forward Voltage	V _F	2.8	----	3.6	V	IF=20mA
Viewing Angle	2θ 1/2	----	120	----	deg	IF=20mA

Note : 1.The forward voltage data did not including $\pm 0.1V$ testing tolerance.
 2. The luminous intensity data did not including $\pm 15\%$ testing tolerance.
 3.The color coordinates measurement allowance is ± 0.01 testing tolerance

Luminous Intensity Classification

BIN CODE	Iv(mcd) at 20mA	
	Min.	Max.
S	200	320
T	320	500
U	500	800

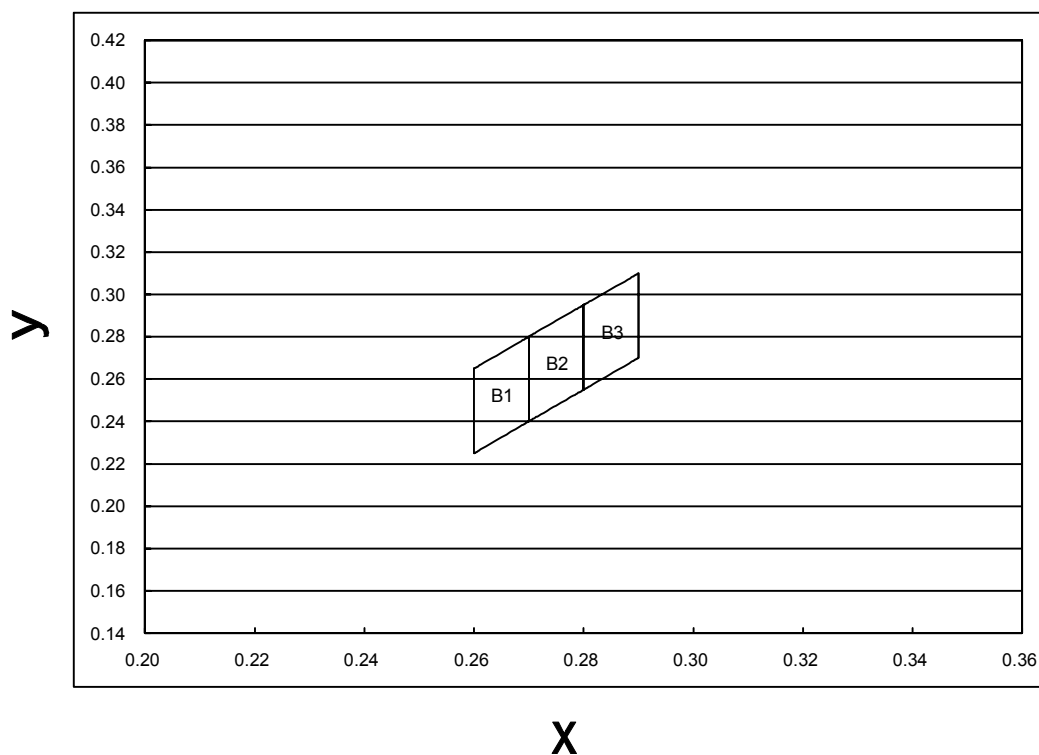
Forward Voltage Classification

BIN CODE	Vf(v) at 20mA	
	Min.	Max.
1	2.8	3.0
2	3.0	3.2
3	3.2	3.4
4	3.4	3.6

. Chromaticity Coordinates Specifications for Bin Grading

Color Coordiante at20mA								
BIN CODE	1		2		3		4	
	x	y	x	y	x	y	x	y
B1	0.26	0.265	0.26	0.225	0.27	0.24	0.27	0.28
B2	0.27	0.28	0.27	0.24	0.28	0.225	0.28	0.295
B3	0.28	0.295	0.28	0.255	0.29	0.27	0.29	0.31

. CIE Chromaticity Diagram



Typical Electro-Optical Characteristics Curve

WK CHIP

Fig.1 Forward current vs. Forward Voltage

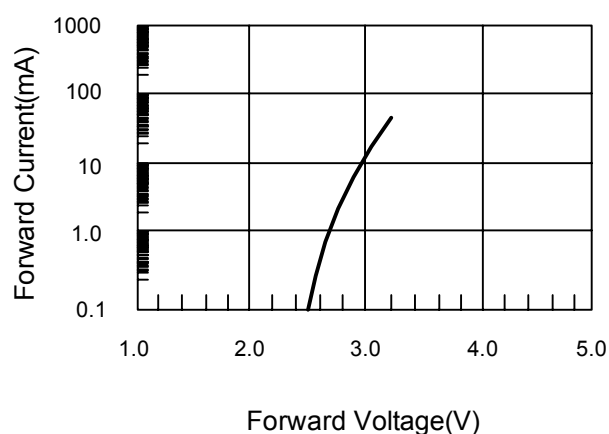


Fig.2 Relative Intensity vs. Forward Current

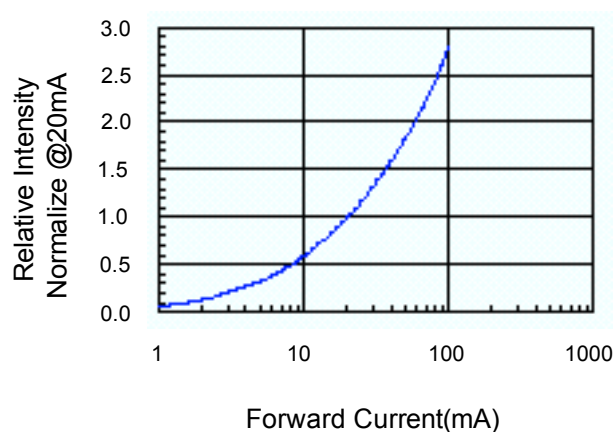


Fig.3 Forward Current vs. Temperature

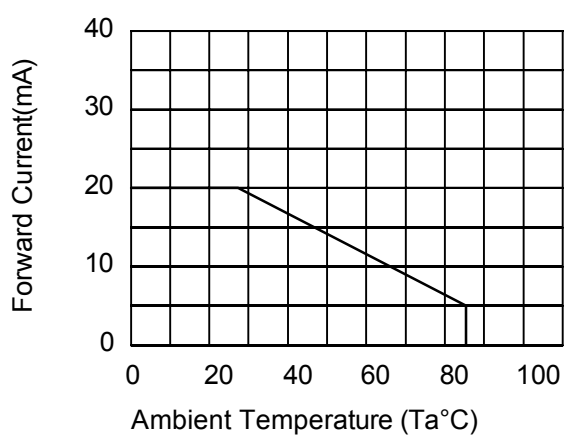


Fig.4 Relative Intensity vs. Temperature

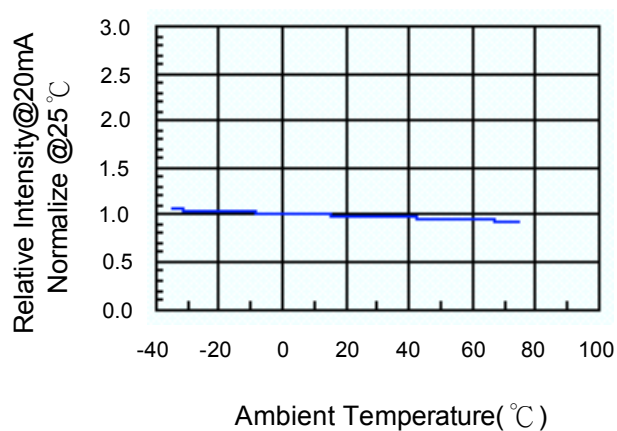


Fig.5 Luminous Spectrum (Ta=25 °C)

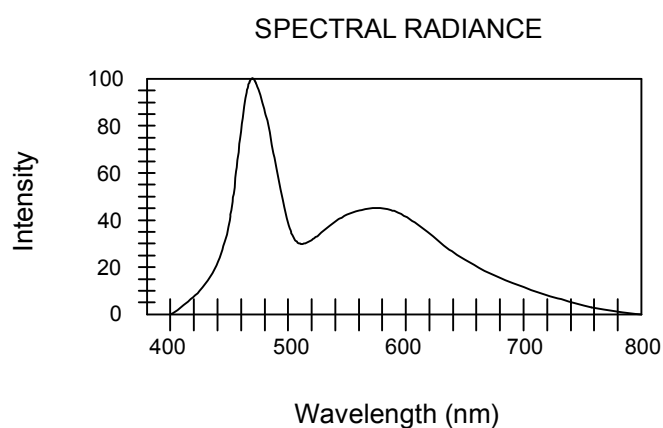
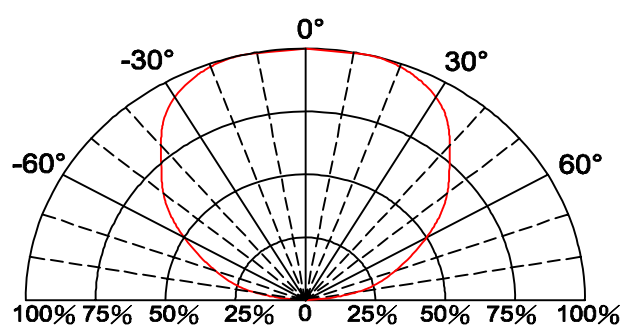


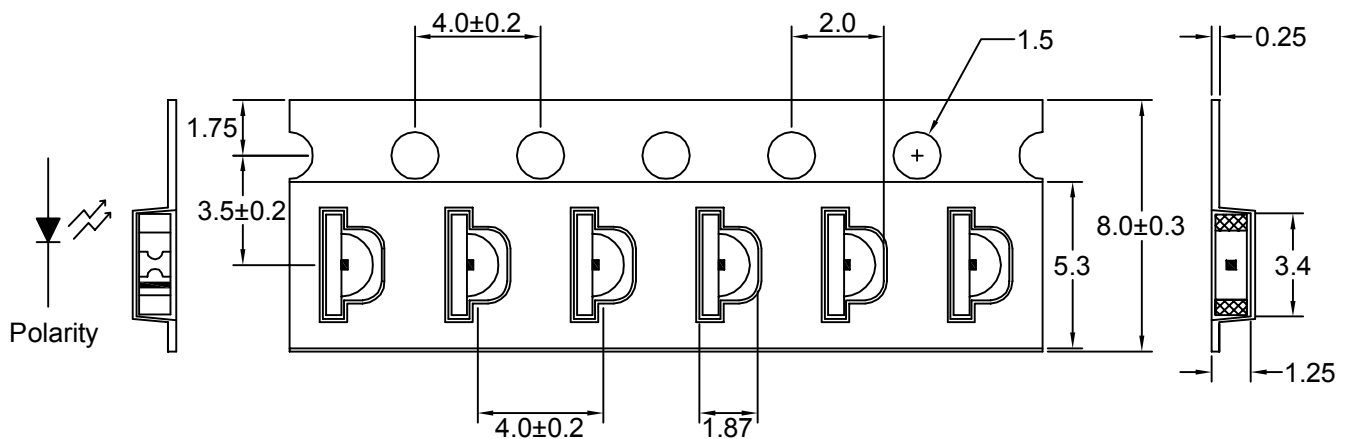
Fig.6 Directive Radiation



PART NO. LG-110WK-DTR-P-B01

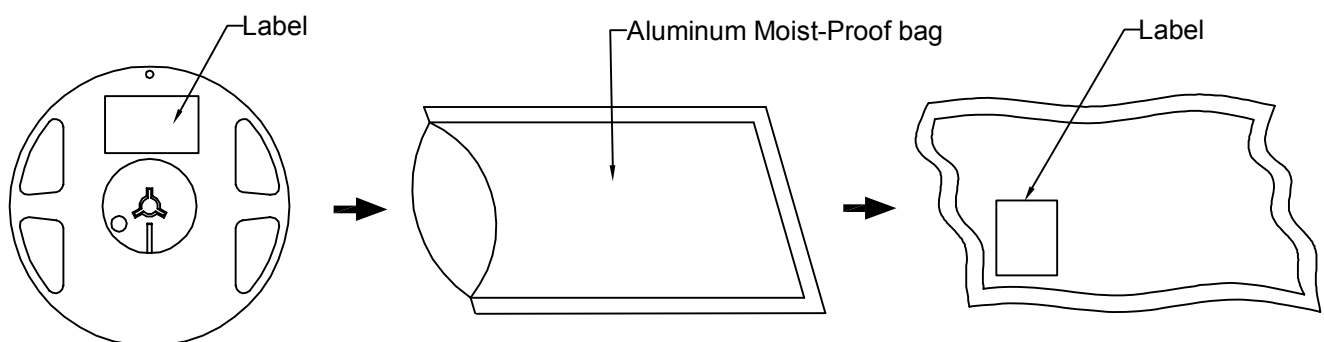
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Carrier Tape Dimensions



Note : The tolerances unless mentioned is ± 0.1 mm, Angle ± 0.5 . Unit=mm.

• Packing Specifications



Part No.	Description	Quantity/Reel
LG-110WK-DTR-P-B01	8.0mm tape, 7" reel	3000 devices

Label Explanation

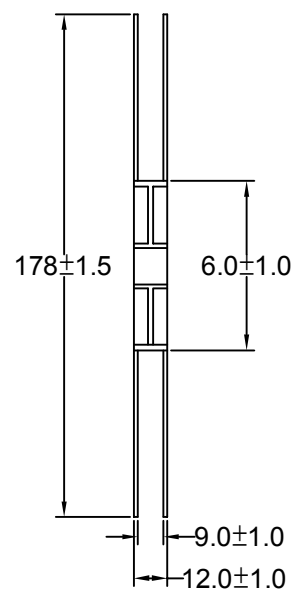
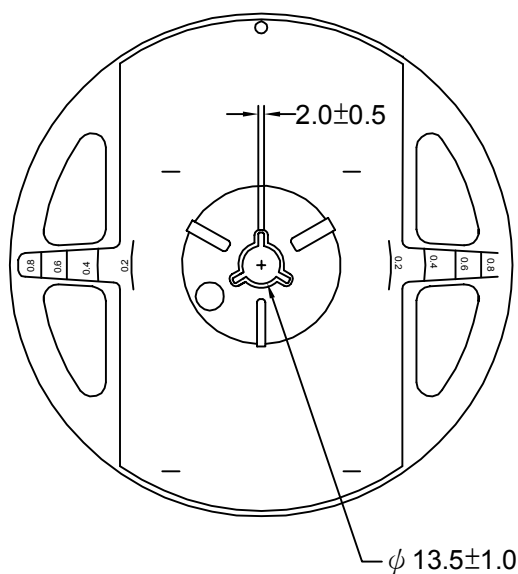
	LIGITEK ELECTRONICS CO., LTD.
PART :	LG-110WK-DTR-P-B01
LOT :	GS11730168
QTY(PCS):	3000
BIN/HUE :	S/B2
	VF:3.0-3.2

BIN : Luminous Intensity

HUE : Chromaticity Coordinates
(CIE_x , CIE_y)

VF : Forward Voltage

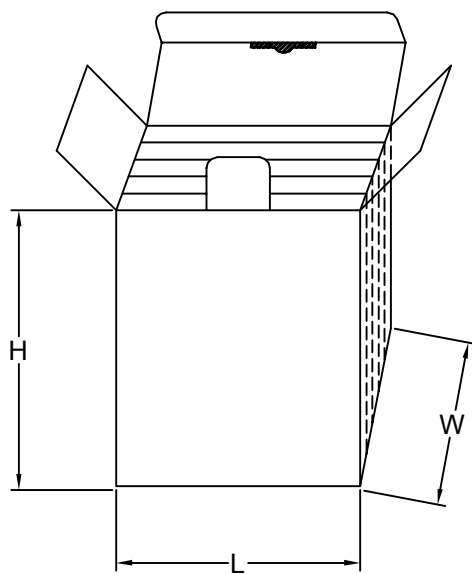
Reel Dimensions



Box Explanation

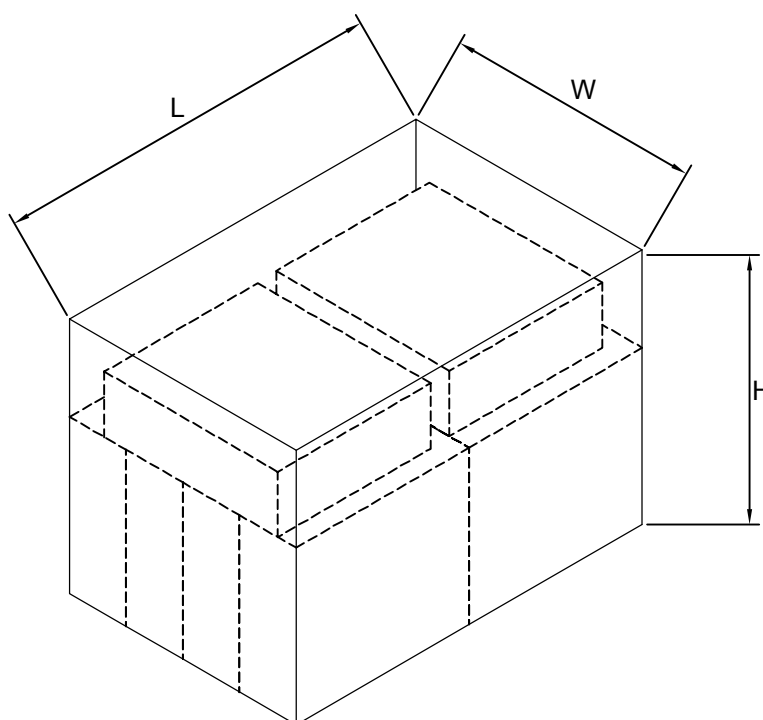
1. 5 BAG / INNER BOX

2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm



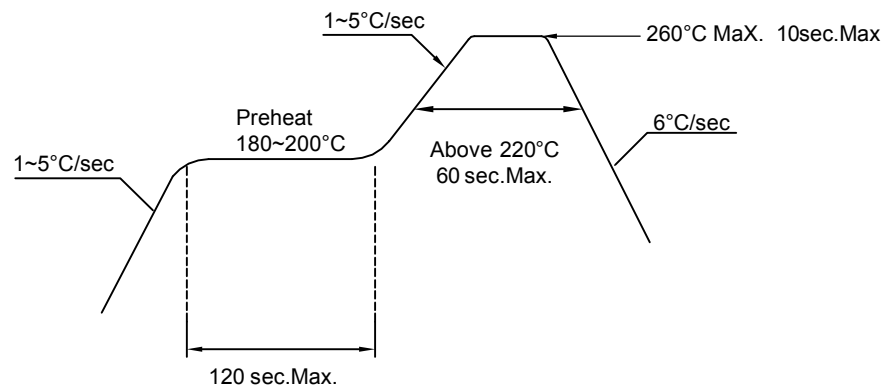
3. 10 INNER BOXES / CARTON

4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



Recommended Soldering Conditions**1. Hand Solder**

Basic spec is $\leq 280^{\circ}\text{C}$ 3 sec one time only.

2. PB-Free Reflow Solder**Note:**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

Precautions For Use:**Storage time:**

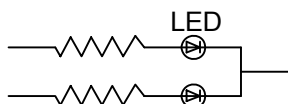
1. Calculated shelf life before opening is 18 months at $< 30^{\circ}\text{C}$ and $< 90\%$ relative humidity (RH)
2. After bag is opened, devices which will be subjected to reflow soldering or other high temperature processes must be
 - a) Assembled within one years in an environment of $\leq 30^{\circ}\text{C} / 60\% \text{ RH}$, or
 - b) Stored at ambient of 10% RH or less
3. Devices are required baking before assembly if:
 - a) Humidity Indicator Card reads $>10\%$ (for level 2a -5a) or $>60\%$ (for level 2) at ambient temperature $23 \pm 5^{\circ}\text{C}$
 - b) 2.a) or 2.b) doesn't meet
4. If baking is required, devices should be baked for >72 hours at $60 \pm 5^{\circ}\text{C} / 5\% \text{ RH}$. Performing baking only once, and using the baked devices within 72 hours..

Drive Method:

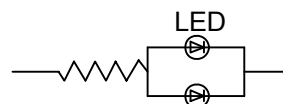
LED is a current operated device, and therefore, requirer some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forwr d current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.

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Reliability Test:

Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1.Ta=25°C 2.If=20mA 3.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature Storage Test	1.Ta=100°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature High Humidity Storage Test	1.Ta=85°C 2.RH=85% 3.t=1000hrs(-24hrs,+72hrs)	22
Environmental Test	Thermal Shock Test	1.Ta=100°C±5°C ~ -40°C±5°C 20min/ 10sec / 20min 2.total 100 cycles	22
	Temperature Cycling	1.100°C±5°C ~ -40°C±5°C 30mins / 5mins / 30mins 2.100 Cyeles	22
	IR Reflow	1.T=260°C Max. 10sec.Max. 2. 6 Min	22